Generic Device:	201	Die MFG:	Harris
Issued By:	G. Jackson CQE	Date:	04/12/2023

This Product Change Notification is Notification of a Major Change.

This change notice is notification of Major change in accordance with current revision of J-STD-046 and Rochester Electronics Internal procedure QIP 92 Governing Customer Change Notification.

Any issues with this PCN or Qualification Requests (Data or Samples) must be sent to Rochester Electronics within 30 days of this PCN publication date.

All requests for data or samples received within the 30-day period will be accommodated based on qualification completion dates and product availability.

Failure to acknowledge PCN within the 30-day notification period is considered as acceptance of PCN.

This PCN 2022_019 is communicating the addition of Rochester Electronics assembly site for device DG201AAK in addition to current MMT subcon assembly site for increased manufacturing capacity.

If you have an order scheduled for shipment within 30 days of this notice, please respond immediately to prevent shipment delays.

Questions on this PCN please contact Customer Quality - CustomerQuality@Rocelec.com

Printed Name	Signature:	Date of Acceptance
Title:	Company:	

	PCN Change Type				
X	Assembly Site		Assembly Process		Assembly Materials

Rochester Electronics[®] Product Change Notification PCN#: 2022-019

	Design	Datasheet/Electrical Spec	Mechanical Specification			
	Wafer Fab Site	Wafer Fab Materials	Wafer Fab Process			
	Test Site	Packing/Shipping/Labeling	Other			
		PCN Details				
Desc	Description of Change:					
Addit	Addition of Rochester Electronics Assembly Site					
Char	nge Details:					
	Change Type	OLD	NEW			
1	Assembly Site	MMT	MMT, RE			
2						
3						
4						
5						
6						
Reas	son for Change:					
	eased additional manufacturing capa	-				
-	osed First Shipment or first Date Co	de of material:				
ARO + 4 weeks						
-	ect to Form, Fit or Function:					
None						
Changes to Product Identification:						
DG201AAK YYWW HARE US YYWW HAMM TH						
Rochester Electronics assembly site marking Microchip assembly site marking						

Form 209 Rev D

Rochester Electronics, LLC • Worldwide Corporate Headquarters • 16 Malcolm Hoyt Drive • Newburyport, MA 01950 USA



Product(s) Affected:						
DG201AAK						
Qualification Data:						
	Included					
X	By Request					
	Not Applicable					



Form 209 Rev D

Rochester Electronics, LLC • Worldwide Corporate Headquarters • 16 Malcolm Hoyt Drive • Newburyport, MA 01950 USA

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